Universal Analytic Model for Ionization Defect Dynamics in Silicon Dioxides

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A pair of analytical formulas is proposed to describe the irradiation-induced defect dynamics of oxide trapped charges (OT) and interface traps (IT) in silicon dioxides. It is shown that, the interplay between a direct creation of OT and an OT-IT interconversion plays an essential role in the defect dynamics. The perfect match between the model and experimental observations for both wet and dry processed oxides, which show strong process fingerprints, nonlinear dose dependence, dose rate sensitivity, and sample variability, is unprecedented, which not only clarifies the physical ambiguity, but also eliminates the computational difficulty encountered in previous standard approaches.

Silicon dioxide is the key material for modern silicon microelectronics. Usually, higher quality gate silicon dioxides are made by a dry oxidation process and used for complementary metal-oxide-semiconductor (CMOS) technology and lower quality base silicon dioxides are made by a wet oxidation process and used for bipolar technology. Under persistent ionizing irradiation, two kinds of ionization defects, i.e., oxide trapped charge (OT) and interface trap (IT) defects, are generated in the insulating dioxide and at its interface with silicon, which are responsible for the degradation of the electrical properties of silicon devices [1]. For both kinds of oxides, the irradiation induced dynamics have been described as a complex generation, transport, and reaction processes of charge carriers, oxygen vacancies, and hydrogen impurities [2, 3]. More specifically, it was believed that the OT is created as a result of an activation of defect precursors and the IT is generated due to the depassivation of interface Si-H bond through protons, which can be released from OT – H$_2$ interaction. Accordingly, a standard approach [4, 5] have to use dozens of coupled nonlinear rate equations to describe the complex processes.

Although some important features of the defect dynamics, such as the time dependent effects [10] and rebound effect [11] in CMOS technology have been successfully explained within the current theoretical framework, this approach, due to the lack of transparency, has also encountered difficulty in explaining some physical observations. For example, an enhanced low-dose-rate sensitivity (ELDRS) of IT has been experimentally found in 1991 [12]. During the last 30 years, many possible mechanisms, such as Coulomb repulsion of space charge on protons [13, 14], hydrogen dimerization [15], and competition between defect reactions [16, 17] have been proposed. However, it is still hard to confirm which mechanism is dominant. Recently, an abnormal non-monotonous dose dependence of OT at relatively low dose rate is also obtained [18], which cannot be explained within the current framework, unless a carrier-recombination-induced energy release is assumed only for the low dose rate case [18]. Finally, it has been widely realized that the wet base oxides and dry gate oxides respond differently under irradiation, especially for the dose rate sensitivity [19]. However, the physical origin for the difference is still not very clear. Besides these puzzling physical observations, the current standard approach also encounters computational difficulties because there are dozens of parameters in the stand approach, and many of them such as the initial concentrations of the neutral trap precursors and the reaction energies are either unknown or difficult to obtain with high certainty [8, 9]. Hence it is very difficult to numerically reproduce the experimental results.

In this Letter we propose a pair of analytical formulas for the irradiation defect dynamics of OT and IT by considering a generation-interconversion framework of the defects and including a creation mechanism of OT. Experimental data of gamma-ray-irradiated base oxide within an extremely wide dose rate range and available data for gate oxide in the literature are used to verify our derived formulas. The perfect match between the model and data under various conditions is unprecedented. The four parameters in the proposed formulas can be directly extracted from the fitting of data, which eliminates the computational difficulties encountered by the current standard approach. The physical ambiguity of the approach can also be clarified by using the verified formulas, because the puzzling ELDRS of IT and non-monotonous dose dependence of OT in base oxide, as well as the different irradiation responses of gate and base oxides can be explicitly explained in terms of the dose rate dependence of the generation and conversion rates.

The microscopic dynamics of the ionization-induced defects in silicon dioxides is very complex. In this work, we
consider the concentration of the defects (N) as the key parameter and extract a generation-interconversion framework from the generation, transport, and reaction processes,

\[ D \xrightarrow{gA} OT \xrightarrow{k_f} IT \]  

(1)

The first part in Eq. (1) is an irreversible generation of OT in the silicon dioxide from the ionization irradiation dose (D). As obtained by Imai et al. [21, 22] and Griscom et al. [23–25] in irradiation experiments of bulk silicon dioxides, the generation of OT is governed by a fractional power law of \( N_{OT}^G = gD^\Delta \), where \( \Delta \) is a fractional exponent between 0 and 1, and \( g \) is a dose-rate-dependent generation rate. The generation rate of OT as a function of dose reads

\[ \frac{\partial N_{OT}^G}{\partial D} = gD^{\Delta-1}. \]  

(2)

As indicated in previous works [23, 26–28], this fundamental behavior happens due to two main reasons. The first is that the OT can be generated not only by \textit{activation} at precursor sites but also by direct \textit{creation} from lattice network by rupture of bonds. The second is that the irradiation drives a Kohlrausch relaxation process [29] in the loosely packed and covalently bonded amorphous network, which leads to time-dependent defect production probabilities [30] and the fractional power law [26]. In existing models [2, 9], only the activation process is considered and a linear dependence is usually assumed for small dose. However, this often leads to large error in effort to achieve a self-consistent description of the experimental data.

The second part in Eq. (1) is a reversible \textit{interconversion} between OT and IT. As indicated by literatures, this process is considered and a linear dependence is usually assumed for small dose. This often leads to large error in effort to achieve a self-consistent description of the experimental data. The proposed formulas predict nonlinear and coupled dynamic behaviors of the two defects under irradiation. First, it predicts that the total concentration of them follows a fractional power law dependence of the ionization dose, \( gD^\Delta \). Second, it predicts OT and IT share a ratio of \( k_b/(k_f + k_b) \) and \( k_f/(k_f + k_b) \) of such a growth term, respectively. Third, OT and IT also display an addition and deduction of an interference term, respectively. The interference term is a product of a power growth function, an exponential decay function, and a \( \Gamma \) function, hence first increases and then decreases with increasing dose.

To test the predictions of the proposed formulas Eq. (4), we first check the available data of dry processed oxides (DPO). In Ref. [37] the shift of threshold voltage of p-channel MOS field-effect transistors is separated into shifts due to OT and IT using the subthreshold-separating method. The obtained \( \Delta V_{OT} \) and \( \Delta V_{IT} \) hence can be regarded as \( \Delta N_{OT} \) and \( \Delta N_{IT} \) only differ by a constant capacitance, respectively, which is investigated as a function of the ionization dose and dose rate. The dose rate varies in 3 order of magnitudes, from 0.05 rad(Si)/s to 51.4 rad(Si)/s. The total concentration is first checked and found to exactly follow the predicted fractional power law. From the model fitting the parameters of \( g \) and \( \Delta \) in Eq. (4) are extracted. The separated data are shown in Fig. 1 as the dots. It is seen that, the two defects show very different nonlinearity in the dose, which is sub-linear for OT and super-linear for IT. The two defects also show clear different dose-rate dependence, which is the ELDRS for IT and the inverse for OT. These data of OT and IT are straightforwardly fitted using the two proposed formulas Eq. (4) with the already extracted parameters \( g \) and \( \Delta \), respectively. The

\[
\Delta N_{OT}(D) = (1 - \lambda)gD^\Delta + \lambda g\tau^\Delta e^{-D/\tau}\Gamma[\Delta, 0, D/\tau],
\]

(4a)

\[
\Delta N_{IT}(D) = \lambda gD^\Delta - \lambda g\tau^\Delta e^{-D/\tau}\Gamma[\Delta, 0, D/\tau].
\]

(4b)

FIG. 1. The shifts of threshold voltage due to generated OT (a) and IT (b) in DPO based p-type MOS as a function of irradiation dose for various dose rates. Dots are for data and curves are for fitting.
fitting curves are plotted in the Figs. (1a) and (1b) as solid curves, respectively. It is seen that, all data of both OT and IT can be uniformly and quantitatively described by the proposed OT and IT formulas, suggesting the physical models underlying the Eq. (4) is correct, that is, the different nonlinearity of OT and IT stems from the addition or deduction of the interference terms, respectively, and the dose-rate sensitivity stems from the dose rate behavior of the parameters, which will be further analyzed below.

To check if the proposed physical process and formulas also work for wet processed oxides (WPO), we prepare high quality data of OT and IT in WPO by carrying out gamma ray irradiation experiments on a large number of samples of gated lateral PNP structure in an extremely wide range of dose rate. The total concentration is extracted from the shift of sub-threshold sweep curves of the structure [38, 39]. The value of ∆N_{OT} is read out from the peak position of the gate sweep curves [40]. The value of ∆N_{IT} is simply calculated by their difference. The dose rate varies from 1 rad/s to 58 µrad/s, which spend 5 order of magnitudes. For each dose rate 3 samples are adopted for sample-to-sample variability [41, 42].

The typical results of obtained ∆N_{OT} and ∆N_{IT} as a function of the gamma ray dose are plotted as the dots in Figs. 2 (a) and 2 (b), respectively. The dose rates are indicated in the figure. It is seen that, the nonlinear dose dependence and dose-rate sensitivity obtained in the DPO are also observed; the latter becomes even stronger for WPO. The most remarkable feature is a non-monotonous dose dependence of OT for dose rate lower than 1 mrad/s. This abnormal behavior was also observed by Li et al. for their 10 mrad/s case [18]. Besides the two features, a big sample-to-sample variability is also observed in the data for both defects, as seen in Fig. 3. The larger the irradiation dose the larger the variability. Again, these data of ∆N_{OT} and ∆N_{IT} are straightforwardly fitted using the two proposed formulas Eq. (4), respectively. It is first found that the sum of them satisfies exactly the predicted fractional power law. The fitting curves of the separated defects are plotted in the Figs. 2 and 3 as solid curves. It is seen that, all data of both OT and IT, which although show strong dose nonlinearity, dose rate sensitivity, and sample-to-sample variability, can be quantitatively and uniformly described by the proposed OT and IT formulas, suggesting the correct physical model behind the formulas. The OT data of Li can also be well fitted by the proposed model; see the insert of Fig. 3 (a).

The excellent agreement between our theoretical model and experiments under various conditions proves the validity and universality of the proposed formulas. The ‘validity’ means the realization of quantitative description of both OT and IT, which are closely related and show strong dose nonlinearity and sample-to-sample variability. The ‘universality’ means the quantitative description can be done simultaneously, not only for both DPO and WPO which show process fingerprints, but also for extremely wide dose rate range which show very different behaviors. The verified formulas uncover that the interplay between the direct creation of OT and the reversible OT-IT interconversion is the dominating mechanism of the complex ionization defect dynamics in silicon dioxides.

Our finding show that the computational difficulty encountered by the standard approach can be totally eliminated by the proposed formulas. It is seen that to quantitatively describe the data, no parameters in the proposed formulas need to be assumed in advance; instead, all the 4 parameters (g, Δ, λ, and τ) can be directly extracted from the fitting of the data. The forward and backward conversion rates k_f and k_b can be further calculated through the relations of k_f = λRτ^{-1} and k_b = (1 - λ)Rτ^{-1}. For the DPO and WPO, the results are shown in Figs. 4 and 5 as the blue and red dots, respectively. As seen in Fig. 4 (b), the fractional exponent Δ is about 2/3 for the DPO but varies between 0.5 and 0.9 for the WPO. The former was also observed in early experiments on MOS capacitors [43, 44]. In Fig. 4 (a) the generation rate decreases slightly for DPO but increases rather strongly for the WPO as...
mechanisms have been speculated for this important effect in rate, which readily leads to the ELDRS of IT. While several
crass of due to the domination of the forward conversion rate and in-
present a clear and explicit explanation. On the other hand,
last 30 years [9, 13–17], our proposed and verified formulas
function of dose rate for both DPO (blue color) and WPO (red color).
are shown by the magenta dots.
dose rate decreases. (Note, the effective generation rate for DPO is reduced by 100 times for clearness.) The propor-
tion factor $\lambda$ in Fig. 4 (c) increases slightly for the DPO but increases strongly and tends to 1 for the WPO when the dose
rate decreases. As shown in Fig. 5, the latter happens because, $k_f$ is dominating at low dose rate but increases more slowly than $k_b$ and becomes comparable with $k_b$ at high dose rate.
The extracted half-life $\tau$ in Fig. 4 (d) decreases with decreasing dose rate for both DPO and WPO. However, the half-life
for DPO are about one order larger than the one for the WPO. The reason is that, both $k_f$ and $k_b$ for DPO are much smaller
than those for WPO at the same dose rate, see Fig. 5. These remarkable divergence in dynamic parameters clearly reflect
the physical essence of the different responses of the two kind of oxides and reflect the fact that the DPO are in general of
higher quality than the WPO. The extracted parameters for Li et. al’s data are also plotted in the Fig. 4 as magenta dots,
which are found to display similar features as our data.

The physical ambiguity encountered by the standard ap-
proach, mainly for the WPO, can also be perfectly solved by the proposed formulas. As indicated by Eq. (4), the dynamics
of OT and IT contain a monotonic growth term and a non-
monotonic interference term, whose strength are determined
by the product of $g$ and $\lambda (1 - \lambda)$. The extracted parameters
in Figs. 4 (a) and 5 show that, due to the increase of the gen-
eration rate and the domination of the forward conversion rate
at lower dose rates, the strength of both the growth and inter-
ference terms in IT (i.e., $\lambda g$) increases with decreasing does
rate, which readily leads to the ELDRS of IT. While several
mechanisms have been speculated for this important effect in
last 30 years [8, 13–17], our proposed and verified formulas
present a clear and explicit explanation. On the other hand,
due to the domination of the forward conversion rate and in-
crease of $\lambda$, with decreasing dose rate, the dominating dynam-
ics of OT changes from the growth mode at high dose rate to
the interference mode at low dose rate. Accordingly, the non-
monotous dose dependence of OT arises. It is noticed that,
by the dose rate sensitivity of the generation and interconver-
sion rates, the totally different but deeply related dose rate de-
pendencies of OT and IT can be explained self-consistently.
From the above analysis, it is also clear that, as the generation
rate and proportion factor are almost insensitive to dose rate,
there was no physical trouble for DPO even using the stand
approach. Actually, the extracted parameters indicate that, the
main reason for the dose rate effects of DPO is the change of
half-life, which is very different from the WPO case.

In summary, we have proposed a universal analytical model
for the two dominant irradiation-induced ionization defects in
silicon dioxides. The key in our model is the consideration of
a generation-interconversion framework and a defect creation
mechanism. The model predicts a combined fractional power
law and exponential decay function of the irradiation dose.
Experimental data for both wet processed base oxides and dry
processed gate oxides are used to verify the proposed mechan-
ism and formulas. It is unprecedented that, the strong process
fingerprints, nonlinear dose dependence, dose rate sensitivity,
and sample variability displayed in the experimental data, can
all be quantitatively and consistently described, which reflects
the validity and universality of our proposed formulas. It is
demonstrated that by using the proposed formulas, the computa-
tional difficulty and physical ambiguity encountered by the
standard approach can be completely eliminated. Especially,
the important but long-time unsettled mechanism of the low-
dose-rate sensitivity of IT and the confusing non-monotonic
dose dependence of OT at relatively low dose rate for wet pro-
cessed oxides can be clearly and uniformly explained in terms
of the dose rate dependence of the generation and intercon-
version rates. Our proposed mechanism and formulas, hence,
provide a powerful tool for understanding the physics of the
irradiation-induced ionization defect dynamics in technically
important silicon and silicon dioxide electronic devices.

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